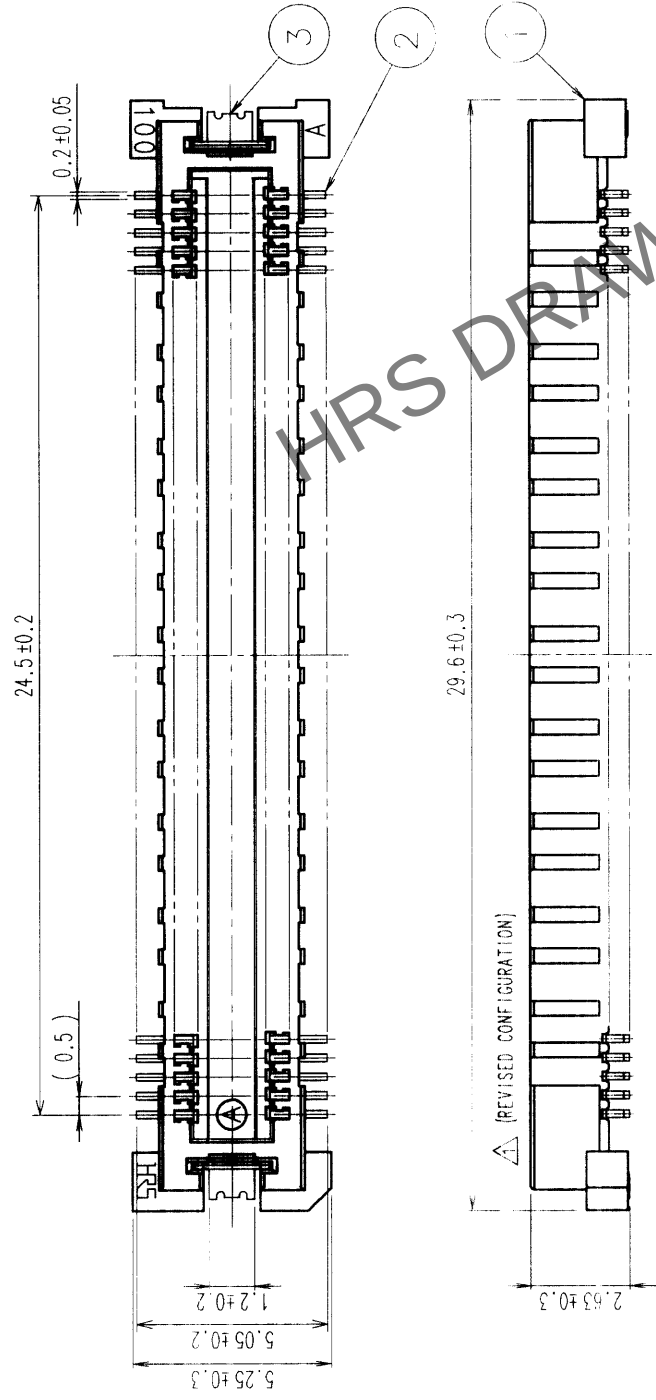
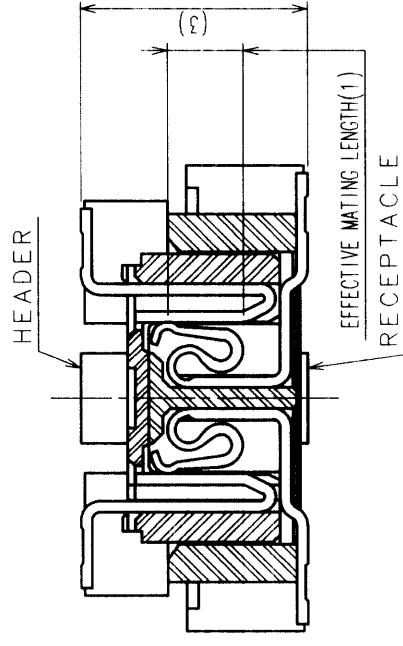
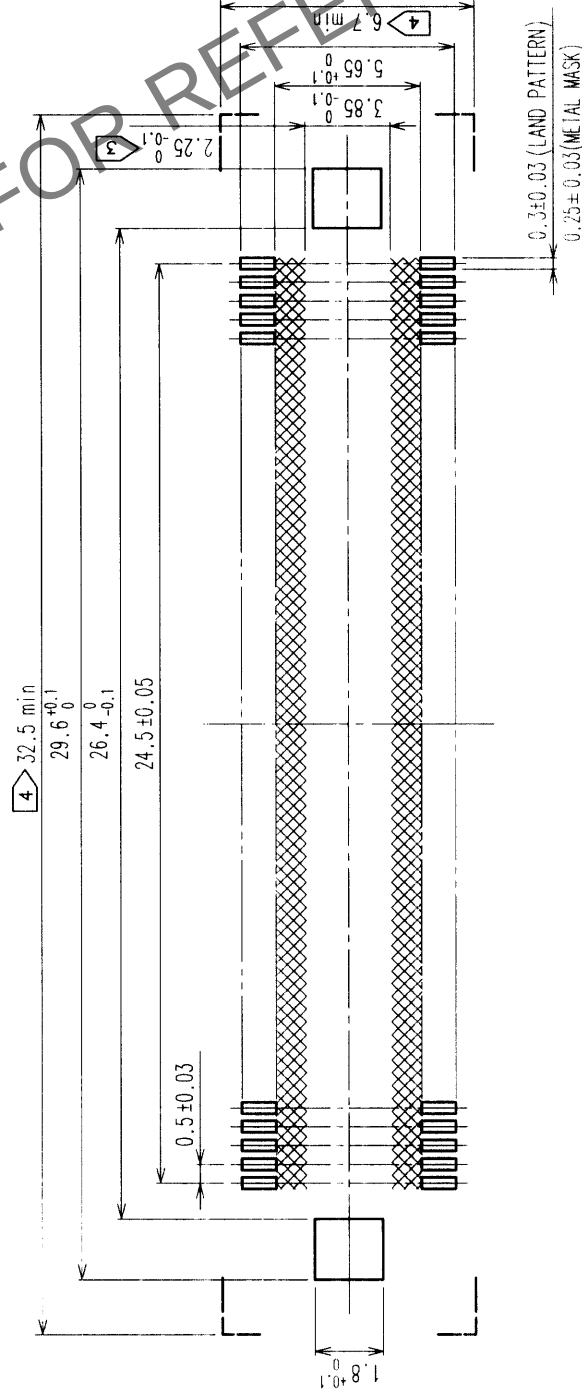


	COUNT	DESCRIPTION OF REVISIONS	B Y	CHKD	DATE	COUNT	DESCRIPTION OF REVISIONS	B Y	CHKD	DATE	
A	1	RE-F-06821	J.M.	H.O.	NO. 04.06	△				.	.
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RECOMMENDED LAND PATTERN DIMENSION OF PCB



2	COPPER ALLOY	CONTACT AREA: GOLD (0.1 μm) OVER NICKEL LEAD: GOLD FLASH OVER NICKEL
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NO.	MATERIAL	FINISH, REMARKS	3	PHOSPHOR BRONZE	TIN PLATED	FINISH, REMARKS
1	LCP	BEIGE UL94V-0				

CODE NO. (OLD) CL	DRAWN	DESIGNED	CHECKED	APPROVED	RELEASED
	J. MATSUKAWA	J. MATSUKAWA	M. ISHIDA	Y. YOSHIMURA	
	00. 01. 15	00. 01. 15	00. 01. 17	00. 01. 17	

			
SCALE		DRAWING NO. EDC3-152628	
5 : 1		PART NO. FX11B-100P-SV0.5	
UNITS		CODE NO.	
mm		CL573-0653-5	
		1 / 1	

NOTES

- 1 SMT LEAD-COPLANARITY:0.1 MAX.
- 2 THIS PRODUCT HAS NO POLARITY TO PATTERN FOR MOUNTING.
- 3 MAKE SURE WIDTH OF PATTERN IS WITHIN THAT OF LAND ,OR LEAD MAY TOUCH PATTERN. (THIS APPLIES TO HATCHED  AREA.)
- 4 DO NOT MOUNT OTHER DEVICES ONTO  AREA ,OR MATING PAIR CANNOT BE MATED.

TO	PCK			
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